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TLC555



SLFS043I-SEPTEMBER 1983-REVISED JULY 2019

TLC555 LinCMOS™ Timer

Features

- Very low power consumption:
 - 1-mW typical at $V_{DD} = 5 \text{ V}$
- Capable of operation in astable mode
- CMOS output capable of swinging rail to rail
- High output current capability
 - Sink: 100-mA typical
 - Source: 10-mA typical
- Output fully compatible with CMOS, TTL, and
- Low supply current reduces spikes during output transitions
- Single-supply operation from 2 V to 15 V
- Functionally interchangeable with the NE555; has same pinout
- ESD protection exceeds 2000 V per MIL-STD-883C, method 3015.2
- Available in Q-temp automotive
 - High-reliability automotive applications
 - Configuration control and print support
 - Qualification to automotive standards

Applications

- Precision timing
- Pulse generation
- Sequential timing
- Time delay generation
- Pulse width modulation
- Pulse position modulation
- Linear ramp generator

3 Description

The TLC555 is a monolithic timing circuit fabricated using the TI LinCMOS™ process. The timer is fully compatible with CMOS, TTL, and MOS logic and operates at frequencies up to 2 MHz. Because of its high input impedance, this device supports smaller timing capacitors than those supported by the NE555 or LM555. As a result, more accurate time delays and oscillations are possible. Power consumption is low across the full range of power-supply voltage.

Like the NE555, the TLC555 has a trigger level equal to approximately one-third of the supply voltage and a threshold level equal to approximately two-thirds of the supply voltage. These levels can be altered by use of the control voltage terminal (CONT). When the trigger input (TRIG) falls below the trigger level, the flip-flop is set and the output goes high. If TRIG is above the trigger level and the threshold input (THRES) is above the threshold level, the flip-flop is reset and the output is low. The reset input (RESET) can override all other inputs and can be used to initiate a new timing cycle. If RESET is low, the flipflop is reset and the output is low. Whenever the output is low, a low-impedance path is provided between the discharge terminal (DISCH) and GND. All unused inputs must be tied to an appropriate logic level to prevent false triggering.

Device Information⁽¹⁾

= = = = = = = = = = = = = = = = = = = =								
PART NUMBER	PACKAGE	BODY SIZE (NOM)						
	SOIC (8)	4.90 mm × 3.91 mm						
TLC555C	PDIP (8)	9.81 mm × 6.38 mm						
1100000	SOP (8)	6.20 mm × 5.30 mm						
	TSSOP (14)	5.00 mm × 4.40 mm						
TLC555I	SOIC (8)	4.90 mm × 3.91 mm						
1100001	PDIP (8)	9.81 mm × 6.38 mm						
TLC555M	LCCC (20)	8.89 mm × 8.89 mm						
ILCOODIVI	CDIP (8)	9.60 mm × 6.67 mm						
TLC555Q	SOIC (8)	4.90 mm × 3.91 mm						

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Simplified Schematic

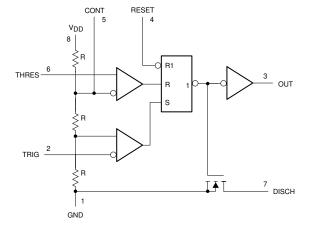




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4 Revision History

Cł	nanges from Revision H (August 2016) to Revision I	Page
•	Added MIN value for input voltage in Absolute Maximum Ratings	6
•	Added discharge pin in Absolute Maximum Ratings	6
•	Changed MIN supply voltage based on part number in Recommended Operating Conditions	6
•	Added power dissipation capacitance TYP value in <i>Electrical Characteristics:</i> $V_{DD} = 2 \text{ V for TLC555C}$, $V_{DD} = 3 \text{ V for TLC555I}$.	7
•	Added trigger, threshold capacitance TYP value in <i>Electrical Characteristics:</i> $V_{DD} = 5 \ V$	
•	Changed V _{OH} test condition current to −1 mA in <i>Electrical Characteristics:</i> V _{DD} = 5 V	8
•	Added power dissipation capacitance TYP value in <i>Electrical Characteristics:</i> $V_{DD} = 5 V$	
•	Added trigger, threshold capacitance TYP value in <i>Electrical Characteristics:</i> $V_{DD} = 15 V$	
•	Added power dissipation capacitance TYP value in <i>Electrical Characteristics:</i> $V_{DD} = 15 \text{ V}$	
•	Added Operating Characteristics to the Specifications section	11
•	Added Supply Current vs Supply Voltage chart to the Typical Characteristics section	12
•	Added Control Impedance vs Temperature chart to the Typical Characteristics section	12
•	Added Output Low Resistance vs Temperature chart to the Typical Characteristics section	12
•	Added Output High Resistance vs Temperature chart to the Typical Characteristics section	12
•	Added Propagation Delay vs Control Voltage chart, V _{DD} = 2 V to the <i>Typical Characteristics</i> section	12
•	Added Propagation Delay vs Control Voltage chart, V _{DD} = 5 V to the <i>Typical Characteristics</i> section	12
•	Changed trigger high hold time to 1 µs in the Monostable Operation section	15
•	Changed minimum monostable pulse width to 1 µs in the Monostable Operation section	15
•	Changed Output Pulse Duration vs Capacitance chart scale down to 0.001 ms in the Monostable Operation section	15
•	Added more astable frequency formulas to the Astable Operation section	17
•	Changed scale on Free-Running Frequency vs Timing Capacitance chart up to 2 MHz in the Astable Operation section	ion 18
•	Added CONT pin table note to the Function Table in the Device Functional Modes section	19
•	Changed the application curve chart in the Pulse-Width Modulation section	22
•	Changed the application curve charts in the Pulse-Position Modulation section	23
•	Added clamping diodes to Sequential Timer Circuit in the Sequential Timer section	24



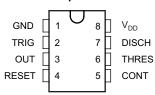
Revision History (continued)

<u>.</u>	Added Designing for Improved ESD Performance section to the Application Information section	25
Cr	nanges from Revision G (November 2008) to Revision H	Page
•	Added Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section	1
•	Changed values in the <i>Thermal Information</i> table to align with JEDEC standards	6
•	Deleted Dissipation Ratings table	6



5 Pin Configuration and Functions

D, P, PS, and JG Packages 8-Pin SOIC, PDIP, SOP, CDIP Top View



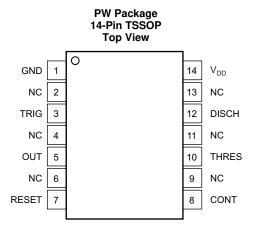
Pin Functions: D, P, PS, and JG Packages

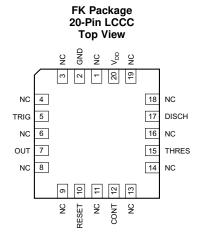
NAME SOIC, PDIP, SOP, CDIP			
		I/O	DESCRIPTION
CONT	5	I	Controls comparator thresholds. Outputs 2/3 V _{DD} and allows bypass capacitor connection.
DISCH	7	0	Open collector output to discharge timing capacitor.
GND	1	_	Ground.
NC	_	_	No internal connection.
OUT	3	0	High current timer output signal.
RESET	4	I	Active low reset input forces output and discharge low.
THRES	6	I	End of timing input. THRES > CONT sets output low and discharge low.
TRIG	2	I	Start of timing input. TRIG < 1/2 CONT sets output high and discharge open.
V_{DD}	8	_	Power-supply voltage.

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Pin Functions: PW and FK

PIN			1/0	DECORPORA				
NAME	TSSOP	LCCC	I/O	DESCRIPTION				
CONT	8	12	I	Controls comparator thresholds. Outputs 2/3 V _{DD} and allows bypass capacitor connection.				
DISCH	12	17	0	Open-collector output to discharge timing capacitor.				
GND	1	2	_	Ground.				
NC	2, 4, 6, 9, 11, 13	1, 3, 4, 6, 8, 9, 11, 13, 14, 16, 18, 19	_	No internal connection.				
OUT	5	7	0	High current timer output signal.				
RESET	7	10	1	Active low reset input forces output and discharge low.				
THRES	10	15	I	End of timing input. THRES > CONT sets output low and discharge low.				
TRIG	3	5	1	Start of timing input. TRIG < 1/2 CONT sets output high and discharge open.				
V_{DD}	14	20	_	Power-supply voltage.				

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6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) (1) Continuous total power dissipation and lead temperature parameters from Absolute Maximum Ratings

			MIN	MAX	UNIT
	Supply, V _{DD} ⁽²⁾	Supply, V _{DD} ⁽²⁾			
Voltage	Input, any input		-0.3	V_{DD}	V
	Discharge	Discharge			
0	Sink, discharge or output		150	A	
Current	Source, output, I _O		15	mA	
	Operating, T _A	C-suffix	0	70	
		I-suffix	-40	85	
T		Q-suffix	-40	125	°C
Temperature		M-suffix	-55	125	30
	Case, for 60 seconds	FK package	-65	150	
	Storage, T _{stg}	-65	150	1	

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
	TLC555C	2	15	
Cumply voltage V	TLC555I	3	15	V
Supply voltage, V _{DD}	TLC555M	5	15	V
	TLC555Q	5	15	
	TLC555C	0	70	
Operating free-air	TLC555I	-40	85	00
temperature, T _A	TLC555M	– 55	125	°C
	TLC555Q	-40	125	

6.3 Thermal Information

		TLC555						
THERMAL METRIC ⁽¹⁾		D (SOIC)	FK (LCCC)	JG (CDIP)	P (PDIP)	PS (SOP)	PW (TSSOP)	UNIT
		8 PINS	20 PINS	8 PINS	8 PINS	8 PINS	14 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	113	n/a	120	58	120	135	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	58	37	81	48	72	61	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	55	36	110	35	69	77	°C/W
ΨЈТ	Junction-to-top characterization parameter	11	n/a	45	26	32	12	°C/W
ΨЈВ	Junction-to-board characterization parameter	54	n/a	103	35	68	77	°C/W
R _{θJC(bot)}	Junction-to-case (bottom) thermal resistance	n/a	4.3	31	n/a	n/a	n/a	°C/W

For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

Product Folder Links: TLC555

⁽²⁾ All voltage values are with respect to network GND.



6.4 Electrical Characteristics: $V_{DD} = 2 \text{ V for TLC555C}$, $V_{DD} = 3 \text{ V for TLC555I}$

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CON	IDITIONS ⁽¹⁾	MIN	TYP	MAX	UNIT
			TLC555C	0.95	1.33	1.65	
		25°C	TLC555I	1.6		2.4	V
/ _{IT}	Threshold voltage		TLC555C	0.85		1.75	
		Full range	TLC555I	1.5		2.5	
			TLC555C		10		
		25°C	TLC555I		10		
IT	Threshold current		TLC555C		75		рA
		Max	TLC555I		150		
			TLC555C	0.4	0.67	0.95	
		25°C	TLC555I	0.71	1	1.29	
/ _{I(TRIG)}	Trigger voltage		TLC555C	0.3		1.05	V
		Full range	TLC555I	0.61		1.39	
			TLC555C		10		
		25°C	TLC555I		10		
I(TRIG)	Trigger current		TLC555C		75		pΑ
		Max	TLC555I		150		
			TLC555C	0.4	1.1	1.5	
V _{I(RESET)}		25°C	TLC555I	0.4	1.1	1.5	V
	Reset voltage	Full range	TLC555C	0.3		2	
			TLC555I	0.3		1.8	
	Control voltage (open-circuit) as a percentage of supply voltage	Max	TLC555C		66.7%		
			TLC555I		66.7%		
	h	I _{OL} = 1 mA, 25°C	TLC555C		0.03	0.2	
	Disabassa suitab sa ataus		TLC555I		0.03	0.2	V
	Discharge switch on-stage voltage	I _{OL} = 1 mA, Full range	TLC555C		0.00	0.25	
	· ·		TLC555I			0.375	
			TLC555C		0.1	0.075	
	Disabassa suitab eff stars	25°C	TLC555I		0.1		nA
	Discharge switch off-stage current		TLC555C		0.5		
		Max	TLC555C		120		
			TLC555C	1.5	1.9		
		$I_{OH} = -300 \ \mu A, \ 25^{\circ}C$	TLC555C	2.5	2.85		
/ _{OH}	High-level output voltage		TLC555C	1.5	2.00		V
		I _{OH} = -300 μA, Full range	TLC555C	2.5			
		9 -	TLC555C	2.5	0.07	0.3	
		I _{OL} = 1 mA, 25°C			0.07	0.3	
/ _{OL}	Low-level output voltage		TLC555I		0.07		V
		I _{OL} = 1 mA, Full range	TLC555C TLC555I			0.35	
						0.4	
		25°C	TLC555C			250	
DD	Supply current ⁽²⁾		TLC555I			250	μΑ
		Full range	TLC555C			400	-
			TLC555I			500	
C_{PD}	Power dissipation	25°C	TLC555C		80		pF
	PD capacitance (3) (4)		TLC555I		90		

⁽¹⁾ Full range is 0°C to 70°C the for TLC555C, and -40°C to 85°C for the TLC555I. For conditions shown as *Max*, use the appropriate

value specified in the *Recommended Operating Conditions* table.

These values apply for the expected operating configurations in which THRES is connected directly to DISCH or to TRIG.

 C_{PD} is used to determine the dynamic power consumption. $P_D = V_{DD}^2 f_0 (C_{PD} + C_L)$ where f_0 = output frequency, C_L = output load capacitance, V_{DD} = supply voltage



6.5 Electrical Characteristics: V_{DD} = 5 V

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CO	ONDITIONS ⁽¹⁾	MIN	TYP	MAX	UNIT
	There are also contained	25°C	TLC555C, TLC555I, TLC555M, TLC555Q	2.8	3.3	3.8	٧
V _{IT}	Threshold voltage	Full range	TLC555C, TLC555I, TLC555M, TLC555Q	2.7		3.9	V
		25°C	TLC555C, TLC555I, TLC555M, TLC555Q		10		
I _{IT}	Threshold current		TLC555C		75		pА
		Max	TLC555I		150		
			TLC555M, TLC555Q		5000		
V _{I(TRIG)}	Trigger voltage	25°C	TLC555C, TLC555I, TLC555M, TLC555Q	1.36	1.66	1.96	V
▼I(TRIG)	mgger voltage	Full range	TLC555C, TLC555I, TLC555M, TLC555Q	1.26		2.06	V
		25°C	TLC555C, TLC555I, TLC555M, TLC555Q		10		
I _{I(TRIG)}	Trigger current		TLC555C		75		pА
		Max	TLC555I		150		1-1-1
			TLC555M, TLC555Q		5000		
C _I	Trigger, threshold capacitance (each pin)	25°C	TLC555C, TLC555I, TLC555M, TLC555Q		2.1		pF
V	Reset voltage	25°C	TLC555C, TLC555I, TLC555M, TLC555Q	0.4	1.1	1.5	V
V _{I(RESET)}		Full range	TLC555C, TLC555I, TLC555M, TLC555Q	0.3		1.8	
	Reset current	25°C	TLC555C, TLC555I, TLC555M, TLC555Q		10		
I _{I(RESET)}		Max	TLC555C		75		pA
,			TLC555I		150		
			TLC555M, TLC555Q		5000		
	Control voltage (open circuit) as a percentage of supply voltage	Max	TLC555C, TLC555I, TLC555M, TLC555Q		66.7%		
	Discharge switch on-stage	I _{OL} = 10 mA, 25°C	TLC555C, TLC555I, TLC555M, TLC555Q		0.14	0.5	V
	voltage	I _{OL} = 10 mA, Full range	TLC555C, TLC555I, TLC555M, TLC555Q			0.6	V
		25°C	TLC555C, TLC555I, TLC555M, TLC555Q		0.1		
	Discharge switch off-stage		TLC555C		0.5		nA
	current	Max	TLC555I		120		
			TLC555M, TLC555Q		120		
V	I link lavel autout valta va	I _{OH} = -1 mA, 25°C	TLC555C, TLC555I, TLC555M, TLC555Q	4.1	4.8		
V _{OH}	High-level output voltage	I _{OH} = -1 mA, Full range	TLC555C, TLC555I, TLC555M, TLC555Q	4.1			V
		I _{OL} = 8 mA, 25°C	TLC555C, TLC555I, TLC555M, TLC555Q		0.21	0.4	
V_{OL}	Low-level output voltage	t voltage I _{OL} = 8 mA, Full range	TLC555C			0.5	V
0.2	. 5		TLC555I			0.5	v
		. sii rango	TLC555M, TLC555Q			0.6	

Product Folder Links: TLC555

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⁽¹⁾ Full range is 0°C to 70°C the for TLC555C, -40°C to 85°C for the TLC555I, -40°C to 125°C for the TLC555Q, and -55°C to 125°C for the TLC555M. For conditions shown as *Max*, use the appropriate value specified in the *Recommended Operating Conditions* table.



Electrical Characteristics: V_{DD} = 5 V (continued)

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CO	ONDITIONS ⁽¹⁾	MIN	TYP	MAX	UNIT
		I _{OL} = 5 mA, 25°C	TLC555C, TLC555I, TLC555M, TLC555Q		0.13	0.3	
			TLC555C			0.4	
		I _{OL} = 5 mA, Full range	TLC555I			0.4	
.,	l and land and and reliance	T dil Talligo	TLC555M, TLC555Q			0.45	
V _{OL}	Low-level output voltage	I _{OL} = 3.2 mA, 25°C	TLC555C, TLC555I, TLC555M, TLC555Q		0.08	0.3	V
			TLC555C			0.35	
		I _{OL} = 3.2 mA, Full range	TLC555I			0.35	
		T dil Talligo	TLC555M, TLC555Q			0.4	
		25°C	TLC555C, TLC555I, TLC555M, TLC555Q		170	350	
I _{DD}	Supply current ⁽²⁾		TLC555C			500	μΑ
ББ		Full range	TLC555I			600	·
			TLC555M, TLC555Q			700	
C _{PD}	Power dissipation capacitance (3) (4)	25°C	TLC555C, TLC555I, TLC555M, TLC555Q		115		pF

- These values apply for the expected operating configurations in which THRES is connected directly to DISCH or to TRIG.
- C_{PD} is used to determine the dynamic power consumption. $P_D = V_{DD}^2 f_0 (C_{PD} + C_L)$ where f_0 = output frequency, C_L = output load capacitance, V_{DD} = supply voltage

6.6 Electrical Characteristics: V_{DD} = 15 V

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST	T CONDITIONS ⁽¹⁾	MIN	TYP	MAX	UNIT
V Throshold voltage		25°C	TLC555C, TLC555I, TLC555M, TLC555Q	9.45	10	10.55	V
V _{IT} Threshold voltage	Full range	TLC555C, TLC555I, TLC555M, TLC555Q	9.35		10.65	V	
		25°C	TLC555C, TLC555I, TLC555M, TLC555Q		10		
I _{IT}	Threshold current		TLC555C		75		pА
		Max	TLC555I		150		
			TLC555M, TLC555Q		5000		
V _{I(TRIG)} Trigger voltage	Trianger valtage	25°C	TLC555C, TLC555I, TLC555M, TLC555Q	4.65	5	5.35	V
	rrigger voltage	Full range	TLC555C, TLC555I, TLC555M, TLC555Q	4.55		5.45	V
	Trigger current	25°C	TLC555C, TLC555I, TLC555M, TLC555Q		10		
I _{I(TRIG)}			TLC555C		75		pA
.()		Max	TLC555I		150		•
			TLC555M, TLC555Q		5000		
Cı	Trigger, threshold capacitance (each pin)	25°C	TLC555C, TLC555I, TLC555M, TLC555Q		1.8		pF
V	Depart valtage	25°C	TLC555C, TLC555I, TLC555M, TLC555Q	0.4	1.1	1.5	٧
V _{I(RESET)} R	Reset voltage	Full range	TLC555C, TLC555I, TLC555M, TLC555Q	0.3		1.8	V
		25°C	TLC555C, TLC555I, TLC555M, TLC555Q		10		
I _{I(RESET)}	Reset current		TLC555C		75		pА
.()		Max	TLC555I		150		•
			TLC555M, TLC555Q		5000		

Full range is 0°C to 70°C for TLC555C, -40°C to 85°C for TLC555I, -40°C to 125°C for the TLC555Q, and -55°C to 125°C for TLC555M. For conditions shown as Max, use the appropriate value specified in the Recommended Operating Conditions table.

Product Folder Links: TLC555



Electrical Characteristics: V_{DD} = 15 V (continued)

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CO	NDITIONS ⁽¹⁾	MIN	TYP	MAX	UNIT	
	Control voltage (open circuit) as a percentage of supply voltage	Max	TLC555C, TLC555I, TLC555M, TLC555Q		66.7%			
	Discharge switch on-stage	I _{OL} = 100 mA, 25°C	TLC555C, TLC555I, TLC555M, TLC555Q		0.77	1.7	٧	
	voltage	I _{OL} = 100 mA, Full range	TLC555C, TLC555I, TLC555M, TLC555Q			1.8	V	
		25°C	TLC555C, TLC555I, TLC555M, TLC555Q		0.1			
	Discharge switch off-stage current		TLC555C		0.5		nA	
	current	Max	TLC555I		120			
			TLC555M, TLC555Q		120			
		I _{OH} = -10 mA, 25°C	TLC555C, TLC555I, TLC555M, TLC555Q	12.5	14.2			
		I _{OH} = -10 mA, Full range	TLC555C, TLC555I, TLC555M, TLC555Q	12.5				
.,	Lligh lovel output voltage	I _{OH} = -5 mA, 25°C	TLC555C, TLC555I, TLC555M, TLC555Q	13.5	14.6		V	
V _{OH}	High-level output voltage	I _{OH} = -5 mA, Full range	TLC555C, TLC555I, TLC555M, TLC555Q	13.5			V	
		I _{OH} = -1 mA, 25°C	TLC555C, TLC555I, TLC555M, TLC555Q	14.2	14.9			
		I _{OH} = -1 mA, Full range	TLC555C, TLC555I, TLC555M, TLC555Q	14.2				
		I _{OL} = 100 mA, 25°C	TLC555C, TLC555I, TLC555M, TLC555Q		1.28	3.2		
		I _{OL} = 100 mA, Full range	TLC555C			3.6		
			TLC555I			3.7		
			TLC555M, TLC555Q			3.8		
		I _{OL} = 50 mA, 25°C	TLC555C, TLC555I, TLC555M, TLC555Q		0.63	1		
V _{OL}	Low-level output voltage		TLC555C			1.3	V	
		I _{OL} = 50 mA, Full range	TLC555I			1.4		
		- an range	TLC555M, TLC555Q			1.5		
		I _{OL} = 10 mA, 25°C	TLC555C, TLC555I, TLC555M, TLC555Q		0.12	0.3		
			TLC555C			0.4		
		I _{OL} = 10 mA, Full range	TLC555I			0.4		
			TLC555M, TLC555Q			0.45		
-		25°C	TLC555C, TLC555I, TLC555M, TLC555Q		360	600		
DD	Supply current ⁽²⁾		TLC555C			800	μΑ	
		Full range	TLC555I			900	•	
			TLC555M, TLC555Q			1000		
C _{PD}	Power dissipation capacitance (3) (4)	25°C	TLC555C, TLC555I, TLC555M, TLC555Q		140		pF	

 ⁽²⁾ These values apply for the expected operating configurations in which THRES is connected directly to DISCH or TRIG.
 (3) C_{PD} is used to determine the dynamic power consumption.
 (4) P_D = V_{DD}² f₀ (C_{PD} + C_L) where f₀ = output frequency, C_L = output load capacitance, V_{DD} = supply voltage

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6.7 Operating Characteristics

 $V_{DD} = 5 \text{ V}, T_A = 25^{\circ}\text{C} \text{ (unless otherwise noted)}$

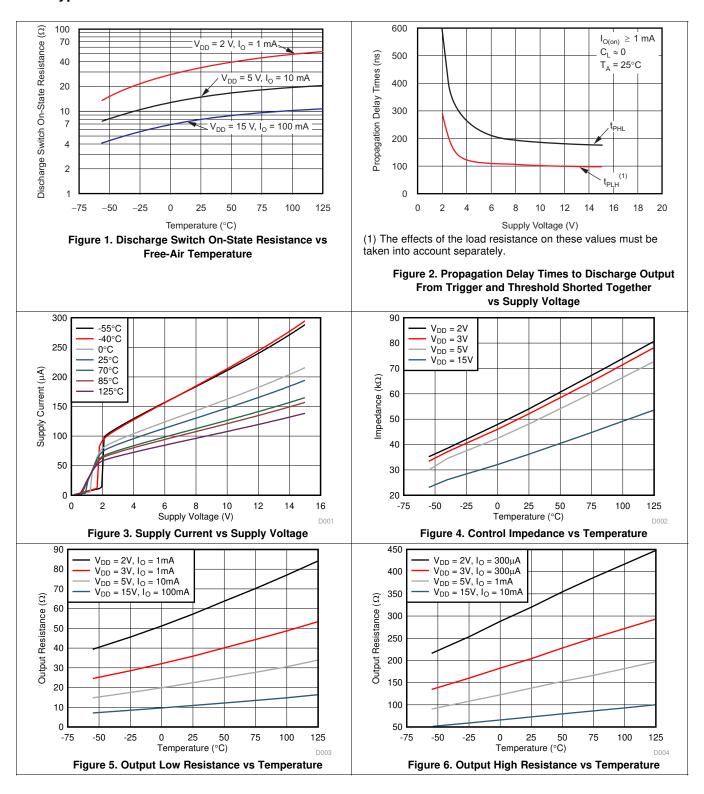
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
	Initial error of timing interval ⁽¹⁾	V_{DD} = 5 V to 15 V, C_T = 0.1 μF R_A = R_B = 1 k Ω to 100 k Ω ⁽²⁾		1%	3%	
	Supply voltage sensitivity of timing interval	V_{DD} = 5 V to 15 V, C_T = 0.1 μF R_A = R_B = 1 k Ω to 100 k Ω ⁽²⁾		0.1	0.5	%/V
t _r	Output pulse rise time	$R_L = 10 \text{ M}\Omega, C_L = 10 \text{ pF}$		20	75	ns
t _f	Output pulse fall time	$R_L = 10 \text{ M}\Omega$, $C_L = 10 \text{ pF}$		15	60	ns
f _{max}	Maximum frequency in a-stable mode	R_{A} = 470 $\Omega,~C_{T}$ = 200 pF R_{B} = 200 $\Omega^{~(2)}$	1.2	2.1		MHz

⁽¹⁾ Timing interval error is defined as the difference between the measured value and the average value of a random sample from each process run.

⁽²⁾ $\overset{\cdot}{R}_A$, R_B , and C_T are as defined in Figure 12.

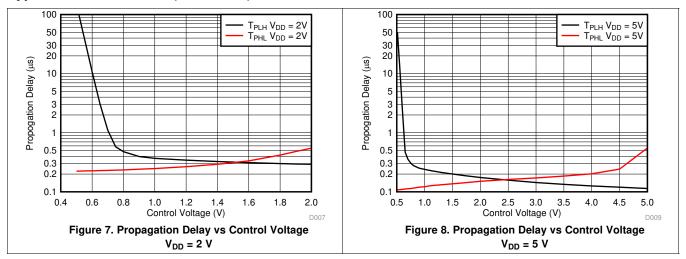
TEXAS INSTRUMENTS

6.8 Typical Characteristics





Typical Characteristics (continued)



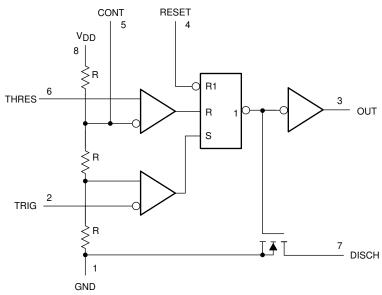


7 Detailed Description

7.1 Overview

The TLC555 is a precision timing device used for general-purpose timing applications up to 2.1 MHz. All inputs are level sensitive not edge triggered inputs.

7.2 Functional Block Diagram



Pin numbers are for all packages except the PW and FK package. RESET can override TRIG, which can override THRES (when CONT pin is $2/3 \text{ V}_{DD}$).

The resistance of "R" resistors vary with V_{DD} and temperature. The resistors match each other very well across V_{DD} and temperature for a temperature stable control voltage ratio.

7.3 Feature Description

7.3.1 Monostable Operation

For monostable operation, any of these timers can be connected as shown in Figure 9. If the output is low, application of a negative-going pulse to the trigger (TRIG) sets the internal latch; the output goes high, and discharge pin (DISCH) becomes open drain. Capacitor C then is charged through R_A until the voltage across the capacitor reaches the threshold voltage of the threshold (THRES) input. If TRIG has returned to a high level, the output of the threshold comparator resets the internal latch, the output goes low, the discharge pin goes low which quickly discharges capacitor C.



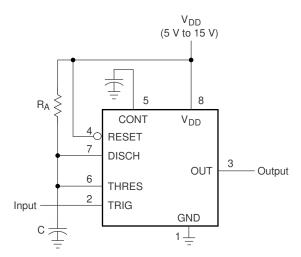
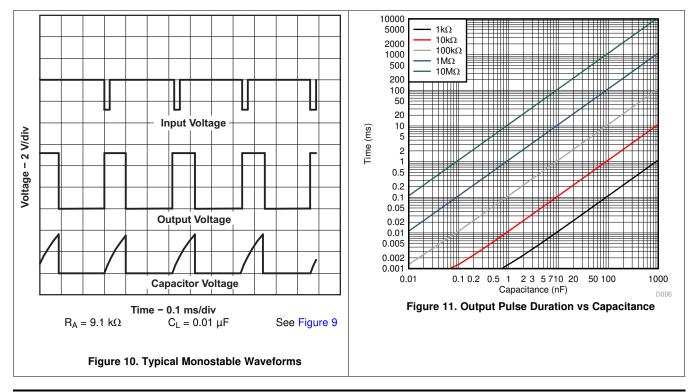


Figure 9. Circuit for Monostable Operation

Monostable operation is initiated when TRIG voltage falls below the trigger threshold. Once initiated, the sequence ends only if TRIG is high for at least 1 μ s before the end of the timing interval. When the trigger is grounded, the comparator storage time can be as long as 1 μ s, which limits the minimum monostable pulse width to 1 μ s. The output pulse duration is approximately $t_w = 1.1 \times R_A C$. Figure 11 is a plot of the time constant for various values of R_A and C. The threshold levels and charge rates both are directly proportional to the supply voltage, V_{DD} . The timing interval is, therefore, independent of the supply voltage, so long as the supply voltage is constant during the time interval.

Applying a negative-going trigger pulse simultaneously to RESET and TRIG during the timing interval discharges capacitor C and reinitiates the cycle, commencing on the positive edge of the reset pulse. The output is held low as long as the reset pulse is low. To prevent false triggering, when RESET is not used it must be connected to $V_{\rm DD}$.





7.3.2 Astable Operation

As shown in Figure 12, adding a second resistor, R_B , to the circuit of Figure 9 and connecting the trigger input to the threshold input causes the timer to self-trigger and run as a multi-vibrator. The capacitor C charges through R_A and R_B and then discharges through R_B only. Therefore, the duty cycle is controlled by the values of R_A and R_B .

This astable connection results in capacitor C charging and discharging between the threshold-voltage level ($\approx 0.67 \times V_{CC}$) and the trigger-voltage level ($\approx 0.33 \times V_{CC}$). As in the monostable circuit, charge and discharge times (and, therefore, the frequency and duty cycle) are independent of the supply voltage.

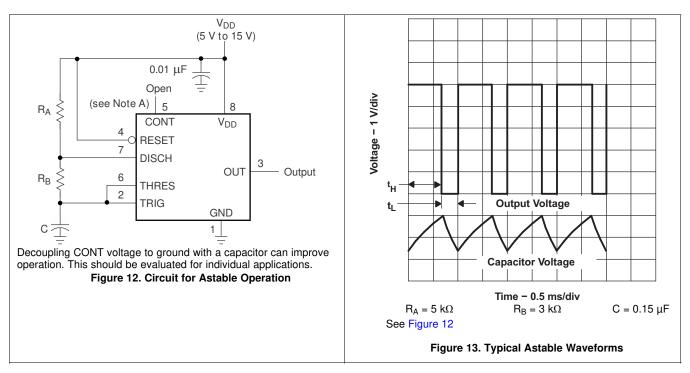


Figure 13 shows typical waveforms generated during a stable operation. The output high-level duration t_H and low-level duration t_I for frequencies below 100 kHz can be calculated as follows:

$$t_{H} = 0.693(R_{A} + R_{B})C$$
 (1)

$$t_{L} = 0.693(R_{B})C \tag{2}$$

Other useful relationships are shown below:

period =
$$t_H + t_L = 0.693 (R_A + 2R_B)C$$
 (3)

frequency
$$\approx \frac{1.44}{(R_A + 2R_B)C}$$
 (4)

Output driver duty cycle =
$$\frac{t_L}{t_H + t_L} = \frac{R_B}{R_A + 2R_B}$$
 (5)

Output waveform duty cycle =
$$\frac{t_H}{t_H + t_L} = 1 - \frac{R_B}{R_A + 2R_B}$$
 (6)

Low-to-high ratio =
$$\frac{t_L}{t_H} = \frac{R_B}{R_A + R_B}$$
 (7)



The formulas (1-7) do not account for any propagation delay times from the TRIG and THRES inputs to DISCH output. These delay times add directly to the period and overcharge the capacitor which creates differences between calculated and actual values that increase with frequency. In addition, the internal on-state resistance r_{on} during discharge adds to R_B to provide another source of timing error in the calculation when R_B is very low. The equations below provide better agreement with measured values. The formulas Equation 8 represent the actual low and high times when used at higher frequencies because propagation delay and discharge on resistance is added to the formulas. Because the formulas are complex, a calculation tool, TLC555 Design Calculator can be used to calculate the component values.

$$t_{c(H)} = C_T (R_A + R_B) ln \left[3 - exp \left(\frac{-t_{PLH}}{C_T (R_B + r_{on})} \right) \right] + t_{PHL}$$

$$t_{c(L)} = C_T (R_B + r_{on}) ln \left[3 - exp \left(\frac{-t_{PHL}}{C_T (R_A + R_B)} \right) \right] + t_{PLH}$$

$$V_{DD}$$

$$t_{PHL}$$

$$t_{c(H)} \longrightarrow t_{c(L)} \longrightarrow$$

Figure 14. Trigger and Threshold Voltage Waveform

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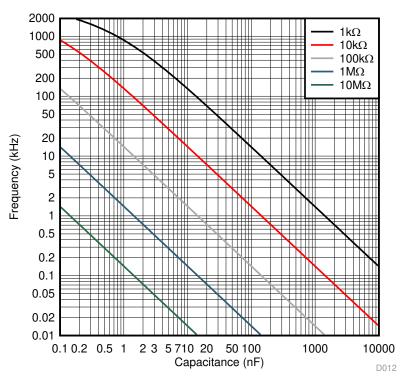
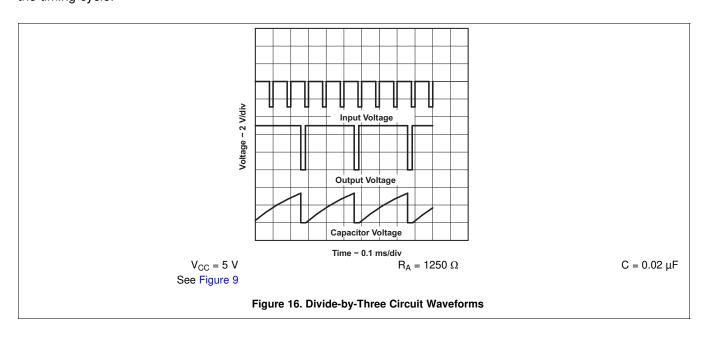


Figure 15. Free-Running Frequency vs Timing Capacitance Resistance = $R_A + 2 \times R_B$

7.3.3 Frequency Divider

By adjusting the length of the timing cycle, the basic circuit of Figure 9 can be made to operate as a frequency divider. Figure 16 shows a divide-by-three circuit that makes use of the fact that re-triggering cannot occur during the timing cycle.





7.4 Device Functional Modes

Table 1 shows the device truth table.

Table 1. Function Table

RESET VOLTAGE ⁽¹⁾	TRIGGER VOLTAGE ⁽¹⁾	TRIGGER VOLTAGE ⁽¹⁾ THRESHOLD VOLTAGE ⁽¹⁾		DISCHARGE SWITCH		
<min< td=""><td>Irrelevant</td><td>Irrelevant</td><td>L</td><td>On</td></min<>	Irrelevant	Irrelevant	L	On		
>MAX	<min< td=""><td>Irrelevant⁽²⁾</td><td>Н</td><td>Off</td></min<>	Irrelevant ⁽²⁾	Н	Off		
>MAX	>MAX	>MAX	L	On		
>MAX	>MAX	<min< td=""><td colspan="4">As previously established</td></min<>	As previously established			

- (1) For conditions shown as MIN or MAX, use the appropriate value specified under *Electrical Characteristics:* $V_{DD} = 5 \text{ V}$.
- (2) CONT pin open or 2/3 V_{DD}.

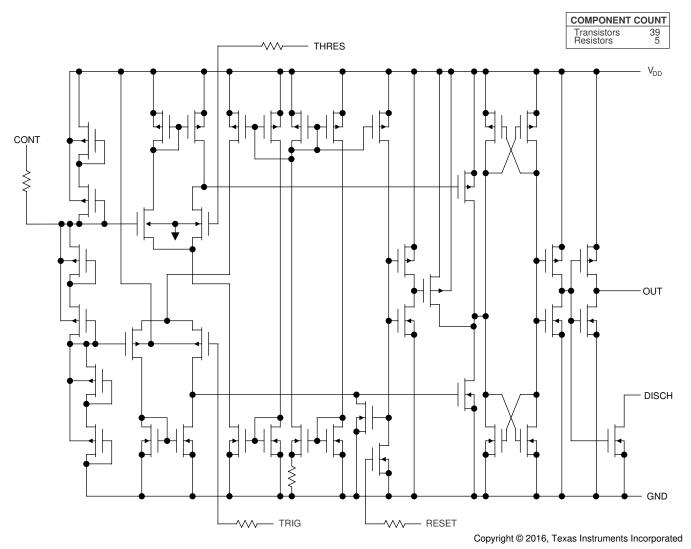


Figure 17. Equivalent Schematic



8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

The TLC555 timer device uses resistor and capacitor charging delay to provide a programmable time delay or operating frequency. The *Typical Applications* section presents a simplified discussion of the design process. Reset mode forces output and discharge low and provides a small reduction in supply current.

8.2 Typical Applications

8.2.1 Missing-Pulse Detector

The circuit shown in Figure 18 can be used to detect a missing pulse or abnormally long spacing between consecutive pulses in a train of pulses. The timing interval of the monostable circuit is re-triggered continuously by the input pulse train as long as the pulse spacing is less than the timing interval. A longer pulse spacing, missing pulse, or terminated pulse train permits the timing interval to be completed, thereby generating an output pulse as shown in Figure 19.

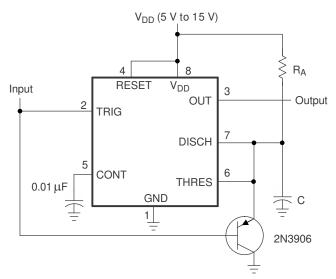


Figure 18. Circuit for Missing-Pulse Detector

8.2.1.1 Design Requirements

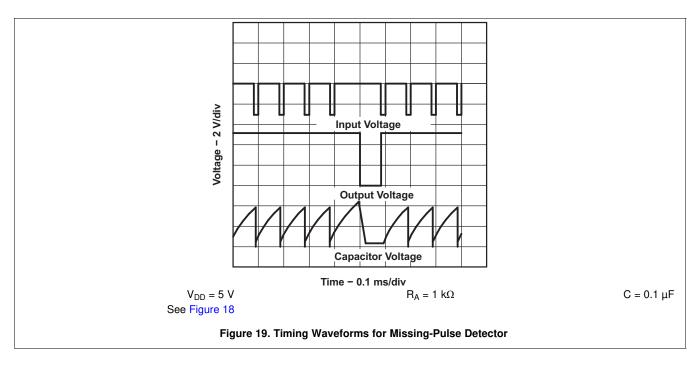
Input fault (missing pulses) must be input high. An input stuck low cannot be detected because the timing capacitor (C) remains discharged.

8.2.1.2 Detailed Design Procedure

Choose R_A and C so that $R_A \times C > [maximum normal input high time].$

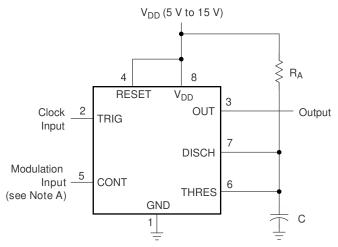


8.2.1.3 Application Curve



8.2.2 Pulse-Width Modulation

The operation of the timer can be modified by modulating the internal threshold and trigger voltages, which is accomplished by applying an external voltage (or current) to CONT. Figure 20 shows a circuit for pulse-width modulation. A continuous input pulse train triggers the monostable circuit, and a control signal modulates the threshold voltage. Figure 21 shows the resulting duty cycle versus control voltage transfer function. Attempting to run under 10% duty cycle could result in inconsistent output pulses. Attempting to run close to 100% duty cycle will result in frequency division by 2, then 3, then 4.



A. The modulating signal can be direct or capacitively coupled to CONT. For direct coupling, consider the effects of modulation source voltage and impedance on the bias of the timer.

Figure 20. Circuit for Pulse-Width Modulation



8.2.2.1 Design Requirements

The clock input must have V_{OL} and V_{OH} levels that are less than and greater than 1/3 V_{DD} , respectively. Clock input V_{OL} time must be less than minimum output high time, therefore a high (positive) duty cycle clock is recommended. Minimum recommended modulation voltage is 1 V. Lower CONT voltage can greatly increase threshold comparator's propagation delay and storage time. The application must be tolerant of a nonlinear transfer function; the relationship between modulation input and pulse width is not linear because the capacitor charge is RC based with an negative exponential curve.

8.2.2.2 Detailed Design Procedure

Choose R_A and C so that $R_A \times C$ is same or less than clock input period. Figure 21 shows the non linear relationship between control voltage and output duty cycle. Duty cycle is function of control voltage and clock period relative to RC time constant.

8.2.2.3 Application Curve

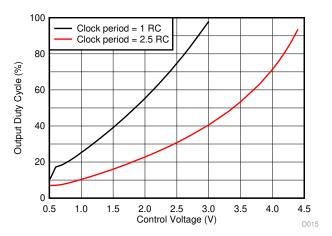
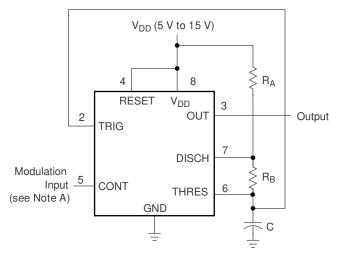


Figure 21. Pulse-Width-Modulation vs Control Voltage Clock Duty Cycle 98%, V_{DD} = 5 V

8.2.3 Pulse-Position Modulation

As shown in Figure 22, any of these timers can be used as a pulse-position modulator. This application modulates the threshold voltage and thereby the time delay of a free-running oscillator. Figure 23 and Figure 24 shows the output frequency and duty cycle versus control voltage.





A. The modulating signal can be direct or capacitively coupled to CONT. For direct coupling, consider the effects of modulation source voltage and impedance on the bias of the timer.

$$R_A = 3 \text{ k}\Omega$$
 $R_B = 309 \text{ k}\Omega$ $C = 1 \text{ nF}$

Figure 22. Circuit for Pulse-Position Modulation

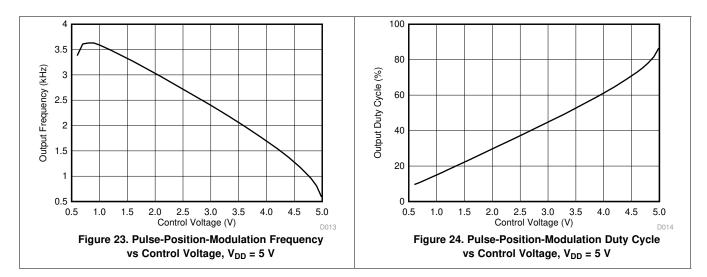
8.2.3.1 Design Requirements

Both DC- and AC-coupled modulation input changes the upper and lower voltage thresholds for the timing capacitor. Both frequency and duty cycle vary with the modulation voltage. Control voltage below 1 V could result in output glitches instead of a steady output pulse stream

8.2.3.2 Detailed Design Procedure

The nominal output frequency and duty cycle for control voltage set to 2/3 of V_{DD} can be determined using formulas in *Astable Operation* section.

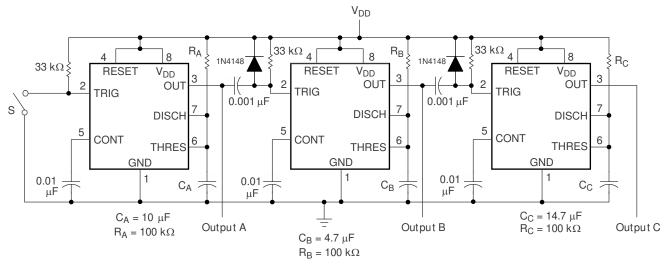
8.2.3.3 Application Curves





8.2.4 Sequential Timer

Many applications, such as computers, require signals for initializing conditions during start-up. Other applications, such as test equipment, require activation of test signals in sequence. These timing circuits can be connected to provide such sequential control. The timers can be used in various combinations of astable or monostable circuit connections, with or without modulation, for extremely flexible waveform control. Figure 25 shows a sequencer circuit with possible applications in many systems, and Figure 26 shows the output waveforms.



NOTE: S closes momentarily at t = 0.

Figure 25. Sequential Timer Circuit

8.2.4.1 Design Requirements

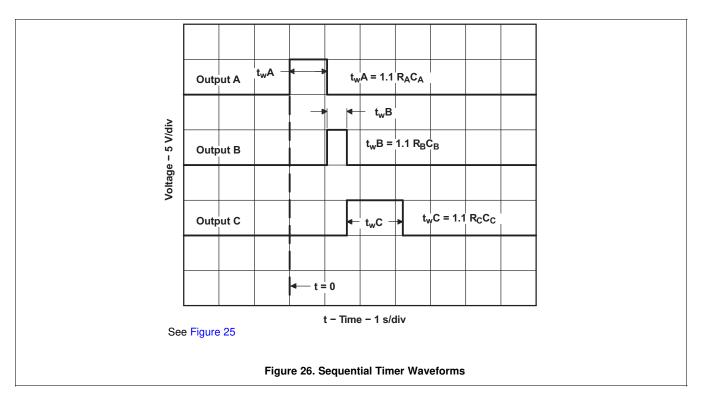
The sequential timer application chains together multiple monostable timers. The joining components are the $33-k\Omega$ resistors and $0.001-\mu F$ capacitors. The output high to low edge passes a $10-\mu s$ start pulse to the next monostable. A diode is needed to prevent over voltage on the trigger input when on the previous output's low to high edge.

8.2.4.2 Detailed Design Procedure

The timing resistors and capacitors can be chosen using this formula: $t_w = 1.1 \times R \times C$.



8.2.4.3 Application Curve



8.2.5 Designing for Improved ESD Performance

The TLC555 internal HBM and CDM protection allows for safe assembly in ESD controlled environments. In applications that may expose pins of the TLC555 to ESD, additional protection is highly recommended. The test board schematic below has bypass capacitors, current-limiting resistors, and voltage clamping TVS diodes to provide additional protection for commonly exposed pins [Reset, Trig, and Output] against ESD.

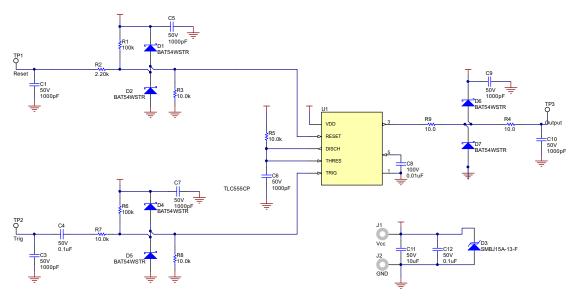


Figure 27. ESD Test Schematic



The table below gives the ESD protection levels recorded for different supply voltages and external components populated. Using only passive components to protect the TLC555 with a single 15-V supply is not recommended because the higher voltage allows for an unacceptable amount of current to flow through the device.

Table 2. ESD test result table

Supply Voltage	Just passive components populated. D1D7 not populated ⁽¹⁾	All components populated (1)
5 V	8 kV	12 kV
15 V	Not recommended	12 kV

⁽¹⁾ Sample results. Results may vary with populated components, board layout, and samples used.

9 Power Supply Recommendations

The TLC555 requires a voltage supply greater than or equal to 2 V, 3 V, or 5 V based the coldest ambient temperature supported and a supply voltage less than or equal to 15 V. Adequate power supply bypassing is necessary to protect associated circuitry and provide stable output pulses. Minimum recommended is 0.1- μ F ceramic in parallel with 1- μ F electrolytic. Place the bypass capacitors as close as possible to the TLC555 and minimize the trace length.



10 Layout

10.1 Layout Guidelines

Standard PCB rules apply to routing the TLC555. The 0.1- μ F ceramic capacitor in parallel with a 1- μ F electrolytic capacitor must be as close as possible to the TLC555. The capacitor used for the time delay must also be placed as close to the discharge pin. A ground plane on the bottom layer can be used to provide better noise immunity and signal integrity.

Figure 28 is the basic layout for various applications.

- C1—based on time delay calculations
- C2—0.01-μF bypass capacitor for control voltage pin
- C3—0.1-μF bypass ceramic capacitor
- C4—1-μF electrolytic bypass capacitor
- R1—based on time-delay calculations

10.2 Layout Example

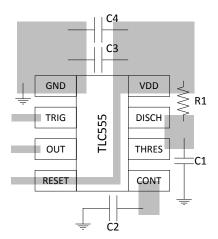


Figure 28. Layout Example



11 Device and Documentation Support

11.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

11.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community.* Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

11.3 Trademarks

LinCMOS, E2E are trademarks of Texas Instruments.

All other trademarks are the property of their respective owners.

11.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

11.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.





10-Dec-2020

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
TLC555CD	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	TL555C	Samples
TLC555CDG4	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	TL555C	Samples
TLC555CDR	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	TL555C	Samples
TLC555CDRG4	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	TL555C	Samples
TLC555CP	ACTIVE	PDIP	Р	8	50	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	TLC555CP	Samples
TLC555CPE4	ACTIVE	PDIP	Р	8	50	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	TLC555CP	Samples
TLC555CPS	ACTIVE	SO	PS	8	80	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	P555	Samples
TLC555CPSR	ACTIVE	SO	PS	8	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	P555	Samples
TLC555CPW	ACTIVE	TSSOP	PW	14	90	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	P555	Samples
TLC555CPWR	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	P555	Samples
TLC555CPWRG4	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	P555	Samples
TLC555ID	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL555I	Samples
TLC555IDG4	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL555I	Samples
TLC555IDR	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL555I	Samples
TLC555IDRG4	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL555I	Samples
TLC555IP	ACTIVE	PDIP	Р	8	50	RoHS & Green	NIPDAU	N / A for Pkg Type	-40 to 85	TLC555IP	Samples
TLC555IPE4	ACTIVE	PDIP	Р	8	50	RoHS & Green	NIPDAU	N / A for Pkg Type	-40 to 85	TLC555IP	Samples
TLC555QDR	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	TL555Q	Samples
TLC555QDRG4	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM		TL555Q	Samples

⁽¹⁾ The marketing status values are defined as follows:



PACKAGE OPTION ADDENDUM

10-Dec-2020

ACTIVE: Product device recommended for new designs.

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LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF TLC555:

Automotive: TLC555-Q1

Military: TLC555M

NOTE: Qualified Version Definitions:

Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects



PACKAGE OPTION ADDENDUM

10-Dec-2020

• Military - QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

www.ti.com 23-Jul-2021

TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLC555CDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLC555CPSR	SO	PS	8	2000	330.0	16.4	8.35	6.6	2.5	12.0	16.0	Q1
TLC555CPWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
TLC555IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLC555QDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLC555QDRG4	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLC555CDR	SOIC	D	8	2500	340.5	336.1	25.0
TLC555CPSR	SO	PS	8	2000	367.0	367.0	38.0
TLC555CPWR	TSSOP	PW	14	2000	853.0	449.0	35.0
TLC555IDR	SOIC	D	8	2500	340.5	336.1	25.0
TLC555QDR	SOIC	D	8	2500	350.0	350.0	43.0
TLC555QDRG4	SOIC	D	8	2500	350.0	350.0	43.0

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
- E. Falls within JEDEC MO-153



PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



- 1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.5. Reference JEDEC registration MS-012, variation AA.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



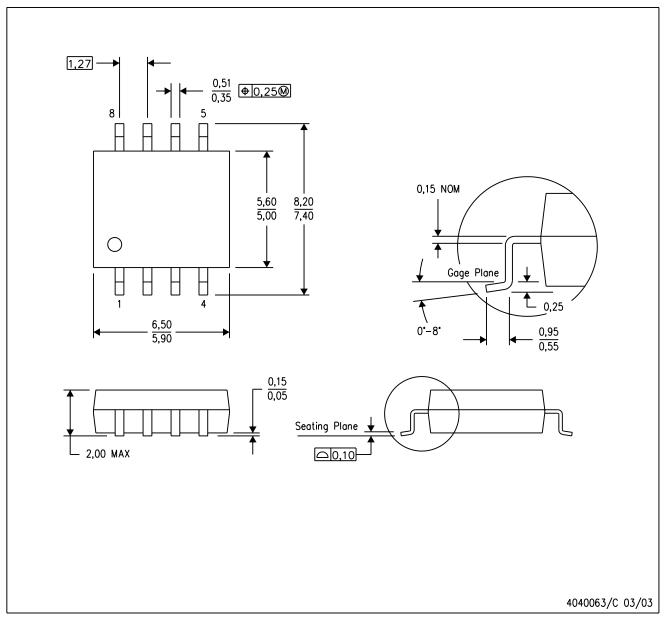
SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.





NOTES: A. All linear dimensions are in millimeters.

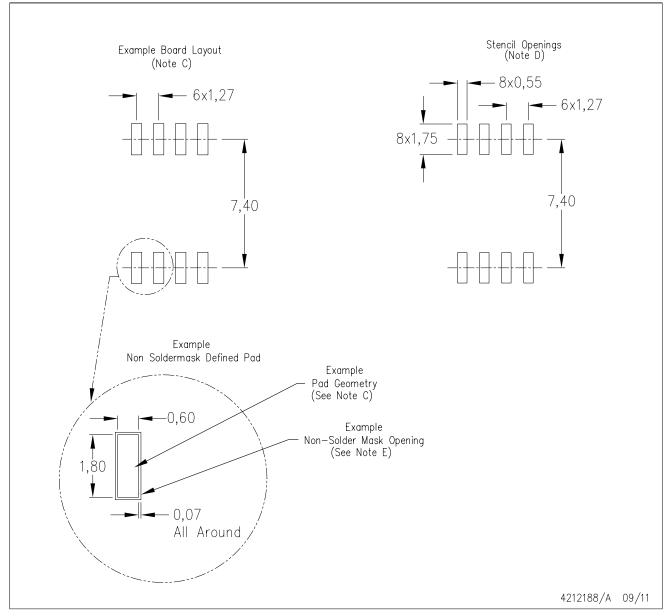
B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



PS (R-PDSO-G8)

PLASTIC SMALL OUTLINE

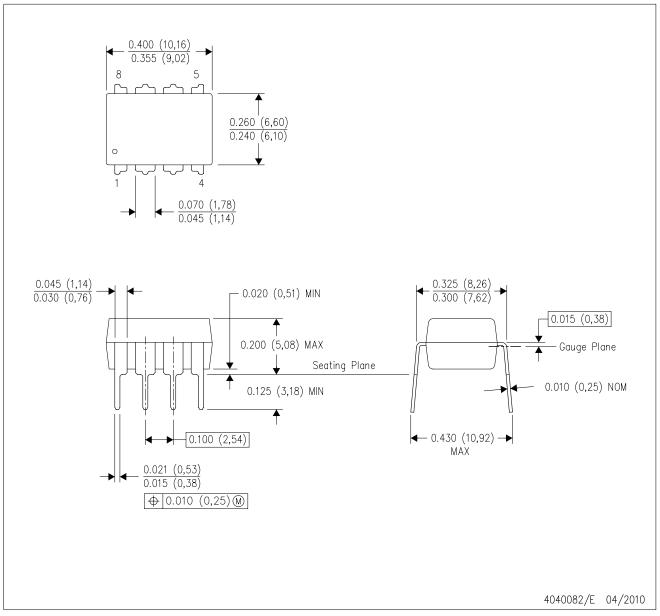


- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 variation BA.



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